506384746 12/04/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6431502

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
THOMAS AICHINGER		12/20/2018
WOLFGANG BERGNER		11/19/2018
PAUL ELLINGHAUS		11/19/2018
RUDOLF ELPELT		11/22/2018
ROMAIN ESTEVE		12/17/2018
FLORIAN GRASSE		12/17/2018
CASPAR LEENDERTZ		12/17/2018
SHIQIN NIU		11/29/2018
DETHARD PETERS		11/22/2018
RALF SIEMIENIEC		11/22/2018
BERND ZIPPELIUS		11/19/2018

RECEIVING PARTY DATA

Name:	INFINEON TECHNOLOGIES AG
Street Address:	AM CAMPEON 1-15
City:	NEUBIBERG
State/Country:	GERMANY
Postal Code:	85579

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17111551

CORRESPONDENCE DATA

Fax Number:	(919)948-3357
	o the e-mail address first; if that is unsuccessful, it will be sent d; if that is unsuccessful, it will be sent via US Mail.
Phone:	9199483390
Email:	official@mbhiplaw.com
Correspondent Name:	MURPHY, BILAK & HOMILLER/INFINEON TECHNO
Address Line 1:	1255 CRESCENT GREEN
Address Line 2:	SUITE 200
Address Line 4:	CARY, NORTH CAROLINA 27518

ATTORNEY DOCKET NUMBER:	1012-2893/2018P50962 US02
NAME OF SUBMITTER:	MARK R. BILAK
SIGNATURE:	/Mark R. Bilak, Reg. No. 47,423/
DATE SIGNED:	12/04/2020
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 25

source=1012-2893 Declaration and Assignment, signed all#page1.tif source=1012-2893 Declaration and Assignment, signed all#page2.tif source=1012-2893 Declaration and Assignment, signed all#page3.tif source=1012-2893 Declaration and Assignment, signed all#page4.tif source=1012-2893 Declaration and Assignment, signed all#page5.tif source=1012-2893 Declaration and Assignment, signed all#page6.tif source=1012-2893 Declaration and Assignment, signed all#page7.tif source=1012-2893 Declaration and Assignment, signed all#page8.tif source=1012-2893 Declaration and Assignment, signed all#page9.tif source=1012-2893 Declaration and Assignment, signed all#page10.tif source=1012-2893 Declaration and Assignment, signed all#page11.tif source=1012-2893 Declaration and Assignment, signed all#page12.tif source=1012-2893 Declaration and Assignment, signed all#page13.tif source=1012-2893 Declaration and Assignment, signed all#page14.tif source=1012-2893 Declaration and Assignment, signed all#page15.tif source=1012-2893 Declaration and Assignment, signed all#page16.tif source=1012-2893 Declaration and Assignment, signed all#page17.tif source=1012-2893 Declaration and Assignment, signed all#page18.tif source=1012-2893 Declaration and Assignment, signed all#page19.tif source=1012-2893 Declaration and Assignment, signed all#page20.tif source=1012-2893 Declaration and Assignment, signed all#page21.tif source=1012-2893 Declaration and Assignment, signed all#page22.tif source=1012-2893 Declaration and Assignment, signed all#page23.tif source=1012-2893 Declaration and Assignment, signed all#page24.tif source=1012-2893 Declaration and Assignment, signed all#page25.tif

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SiC Trench Transistor Device and Methods of Manufacturing Thereof

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I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

WHEREAS, the undersigned has invented certain at least one claim in the application identified.

WHEREAS, Infineon Technologies AG

of Am Campeon 1-15, 85579 Neubiberg, Germany

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

in any foreign countries.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these considerations does (do) sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions of all of the above for the full term or terms for which the same may be granted.

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In witness whereof, executed by the undersigned on the date opposite the undersigned name.

Full Name of Inventor:

Qo. 17. 2018____

Full Name of Inventor:

Date

Thomas Aichinger

/C.X.:.... Inventor Signature

Wolfgang Bergner

Inventor Signature

Paul Ellinghaus

Inventor Signature

Rudolf Elpelt

Inventor Signature

Romain Esteve

Inventor Signature

Page 2 of 3

Full Name of Inventor: Inventor Signature Date Full Name of Inventor: **Caspar Leendertz** Date Inventor Signature Full Name of Inventor: Shiqin Niu Date Inventor Signature Full Name of Inventor: **Dethard Peters** Inventor Signature Date **Ralf Siemienlec** Full Name of Inventor: Inventor Signature Date **Bernd Zippelius** Full Name of Inventor:

Date

Florian Grasse

Inventor Signature

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Full Name of Inventor:	Thomas Aichinger
Date	Inventor Signature
Full Name of Inventor: 11/19/2018	Wolfgang Bergner
Full Name of Inventor:	Inventor Signature Paul Ellinghaus
Date	Inventor Signature
Full Name of Inventor:	Rudolf Elpelt
Date	Inventor Signature
Full Name of Inventor:	Romain Esteve
Date	Inventor Signature

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Full Name of Inventor:

Thomas Aichinger

Inventor Signature

Wolfgang Bergner

Inventor Signature

Date

Full Name of Inventor:

Date

Full Name of Inventor:

19 November 2018 Date

Full Name of Inventor:

Date

Romain Esteve

Full Name of Inventor:

Date

Inventor Signature

Page 2 of 3

Paul Ellinghaus Inventor Signature

Rudolf Elpelt

Inventor Signature

Full Name of Inventor:	Florian Grasse
Date	Inventor Signature
Full Name of Inventor:	Caspar Leendertz
Date	Inventor Signature
Full Name of Inventor:	Shiqin Niu
Date	Inventor Signature
Full Name of Inventor:	Dethard Peters
Date	Inventor Signature
Full Name of Inventor:	Ralf Siemieniec
Date	Inventor Signature
Full Name of Inventor:	Bernd Zippelius

Date

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Full Name of Inventor:

Thomas Aichinger

Date

Full Name of Inventor:

Date

Full Name of Inventor:

Date

Full Name of Inventor:

2018-11-72

Date

Full Name of Inventor;

Date

Inventor Signature

Wolfgang Bergner

Inventor Signature

Paul Ellinghaus

Inventor Signature

Rudolf Elpelt nd of Elpelt

Inventor Signature

Romain Esteve

Inventor Signature

PATENT REEL: 054587 FRAME: 0276

Page 2 of 3

Full Name of Inventor:

Date

Full Name of Inventor:

Date

Full Name of Inventor:

Date

Full Name of Inventor:

<u>Z018-11-22</u> Date

Full Name of Inventor:

Date

Full Name of Inventor:

2018-M-1

Date

Florian Grasse

Inventor Signature

Caspar Leendertz

Inventor Signature

Shiqin Niu

Inventor Signature

Dethard Peters

Inventor Signature

Ralf Slemieniec

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Bernd Zippelius Carro a

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Thomas Aichinger

Date

Full Name of Inventor:

17/11/2018

Date

Wolfgang Bergner

Inventor Signature

Inventor Signature

Paul Ellinghaus

Inventor Signature

Rudolf Elpelt

Inventor Signature

Romain Esteve Inventor Signature

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Date	Inventor Signature
Full Name of Inventor.	Wolfgang Bergner
Date	Inventor Signature
Full Name of Inventor:	Paul Ellinghaus
Date	Inventor Signature
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Date	Inventor Signature
Full Name of Inventor:	Romain Esteve
Date	Inventor Signature

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Full Name of Inventor: <u>/֏,/</u> ʔ, / ͡ Date	Florian Grasse Inventor-Signature
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NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these considerations does (do) sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions of all of the above for the full term or terms for which the same may be granted.

The undersigned agrees to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof or any other proceedings before the United States Patent and Trademark Office and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agrees to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

Page 1 of 3

The undersigned agrees to perform all affirmative acts which may be necessary to obtain a grant of (a) valid United States of America patent(s) and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorizes and requests the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has the full right to convey the entire interest herein assigned, and that he has not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grants the Assignee's legal representatives the power to insert, before or after this document has been executed by the undersigned, any information to identify the instant patent application which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office.

The undersigned hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

The undersigned hereby acknowledges that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

In witness whereof, executed by the undersigned on the date opposite the undersigned name.

Full Name of Inventor:	Thomas Alchinger
Date	Inventor Signature
Full Name of Inventor:	Wolfgang Bergner
Date	Inventor Signature
Full Name of Inventor:	Paul Ellinghaus
Date	Inventor Signature
Full Name of Inventor:	Rudolf Elpelt
Date	Inventor Signature
Full Name of Inventor.	Romain Esteve
Date	Inventor Signature

Signature

Page 2 of 3

Full Name of Inventor:

Date

Full Name of Inventor:

12.2012

Full Name of Inventor:

Date

Florian Grasse

Inventor Signature

Caspar Leendertz

Inventor Signature

Shiqin Niu

Inventor Signature

Dethard Peters

Inventor Signature

Ralf Siemieniec

Inventor Signature

Bernd Zippelius

Inventor Signature

PATENT REEL: 054587 FRAME: 0286

Page 3 of 3

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

SiC Trench Transistor Device and Methods of Manufacturing Thereof

As a below named inventor (hereinafter designated as the undersigned), I hereby declare that:

This declaration is directed to the application attached hereto. If the application is not attached hereto, the application is as identified by the attorney docket number as set forth above and/or the following:

United States Application Number or PCT International Appln. No. 16/193,296

filed on Nov 16, 2018.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

WHEREAS, the undersigned has invented certain at least one claim in the application identified.

WHEREAS, Infineon Technologies AG

of Am Campeon 1-15, 85579 Neubiberg, Germany

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

in any foreign countries.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these considerations does (do) sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions of all of the above for the full term or terms for which the same may be granted.

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The undersigned hereby grants the Assignee's legal representatives the power to insert, before or after this document has been executed by the undersigned, any information to identify the instant patent application which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office.

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In witness whereof, executed by the undersigned on the date opposite the undersigned name.

Full Name of Inventor:	Thomas Aichinger
Date	Inventor Signature
Full Name of Inventor:	Wolfgang Bergner
Date	Inventor Signature
Full Name of Inventor:	Paul Ellinghaus
Date	Inventor Signature
Full Name of Inventor:	Rudolf Elpelt
Date	Inventor Signature
Full Name of Inventor:	Romain Esteve
Date	Inventor Signature

Page 2 of 3

Full Name of Inventor:	Florian Grasse
Date	Inventor Signature
Full Name of Inventor:	Caspar Leendertz
Date	Inventor Signature
Full Name of Inventor:	Shiqin Niu
<u>29.11.2018</u>	AF Inventor Signature
Date	
Full Name of Inventor:	Dethard Peters
Date	Inventor Signature
Full Name of Inventor:	Ralf Siemieniec
Date	Inventor Signature
Full Name of Inventor:	Bernd Zippelius
Date	Inventor Signature

Docket Number: 1012-2179 / 2018P50962 US

DECLARATION AND ASSIGNMENT FOR PATENT AND DESIGN APPLICATIONS

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

SiC Trench Transistor Device and Methods of Manufacturing Thereof

As a below named inventor (hereinafter designated as the undersigned), I hereby declare that:

This declaration is directed to the application attached hereto. If the application is not attached hereto, the application is as identified by the attorney docket number as set forth above and/or the following:

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The above-identified application was made or authorized to be made by me.

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The undersigned hereby acknowledges that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

In witness whereof, executed by the undersigned on the date opposite the undersigned name:

Full Name of Inventor: **Thomas Aichinger** Date Full Name of Inventor: Date Full Name of Inventor: Date Full Name of Inventor: Date Full Name of Inventor:

Inventor Signature

Wolfgang Bergner

Inventor Signature

Paul Ellinghaus

Inventor Signature

Rudolf Elpelt

Inventor Signature

Romain Esteve

Date

Inventor Signature

Full Name of Inventor:

Date

Full Name of Inventor: 22.008

Date

Full Name of Inventor:

Date

Florian Grasse

Inventor Signature

Caspar Leendertz

Inventor Signature

Shiqin Niu

Inventor Signature

Dethard Peters

Inventor Signature

Ralf Siemieniec Induz

Inventor Signature

Bernd Zippelius

Inventor Signature

PATENT REEL: 054587 FRAME: 0292

RECORDED: 12/04/2020

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